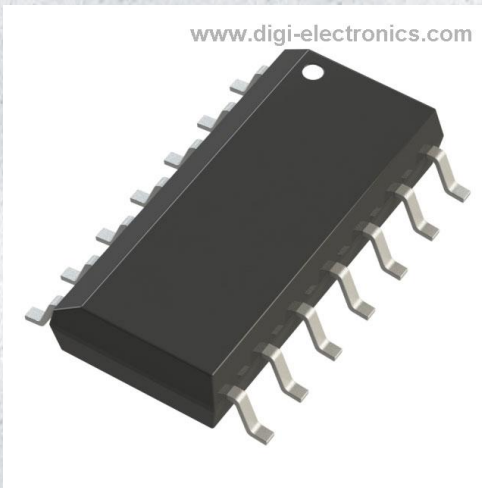


74HCT03D-Q100J Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	74HCT03D-Q100J-DG
Manufacturer	Nexperia USA Inc.
Manufacturer Product Number	74HCT03D-Q100J
Description	IC GATE NAND 4CH 2-INP 14SO
Detailed Description	NAND Gate IC 4 Channel Open Drain 14-SO



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

74HCT03D-Q100J

Series:

74HCT

Logic Type:

NAND Gate

Number of Inputs:

2

Voltage - Supply:

4.5V ~ 5.5V

Current - Output High, Low:

-, 4mA

Input Logic Level - High:

2V

Operating Temperature:

-40°C ~ 125°C

Qualification:

AEC-Q100

Supplier Device Package:

14-SO

Base Product Number:

74HCT03

Manufacturer:

Nexperia USA Inc.

Product Status:

Active

Number of Circuits:

4

Features:

Open Drain

Current - Quiescent (Max):2 μ A**Input Logic Level - Low:**

0.8V

Max Propagation Delay @ V, Max CL:

24ns @ 4.5V, 50pF

Grade:

Automotive

Mounting Type:

Surface Mount

Package / Case:

14-SOIC (0.154", 3.90mm Width)

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



74HC03-Q100; 74HCT03-Q100

Quad 2-input NAND gate; open-drain output

Rev. 4 — 16 February 2024

Product data sheet

1. General description

The 74HC03-Q100; 74HCT03-Q100 is a quad 2-input NAND gate with open-drain outputs. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

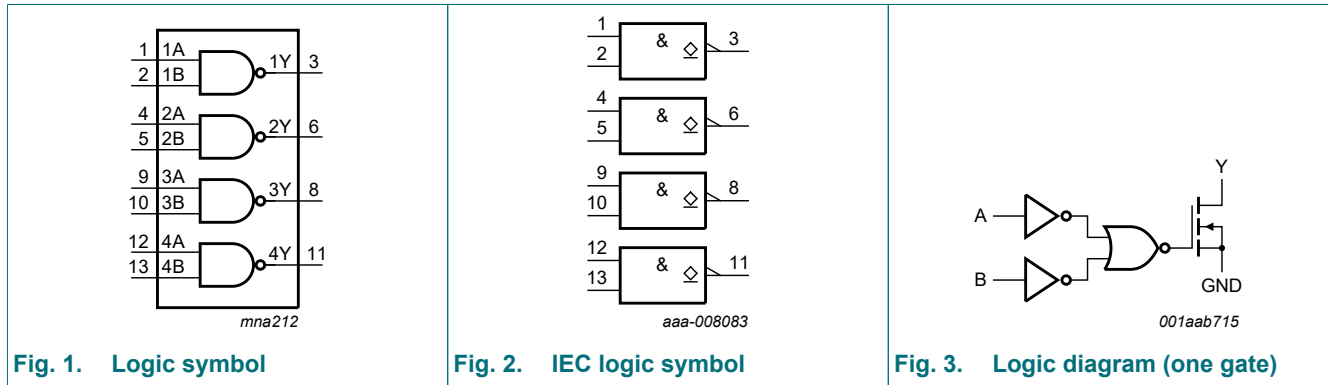
- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC03-Q100: CMOS level
 - For 74HCT03-Q100: TTL level
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

3. Ordering information

Table 1. Ordering information

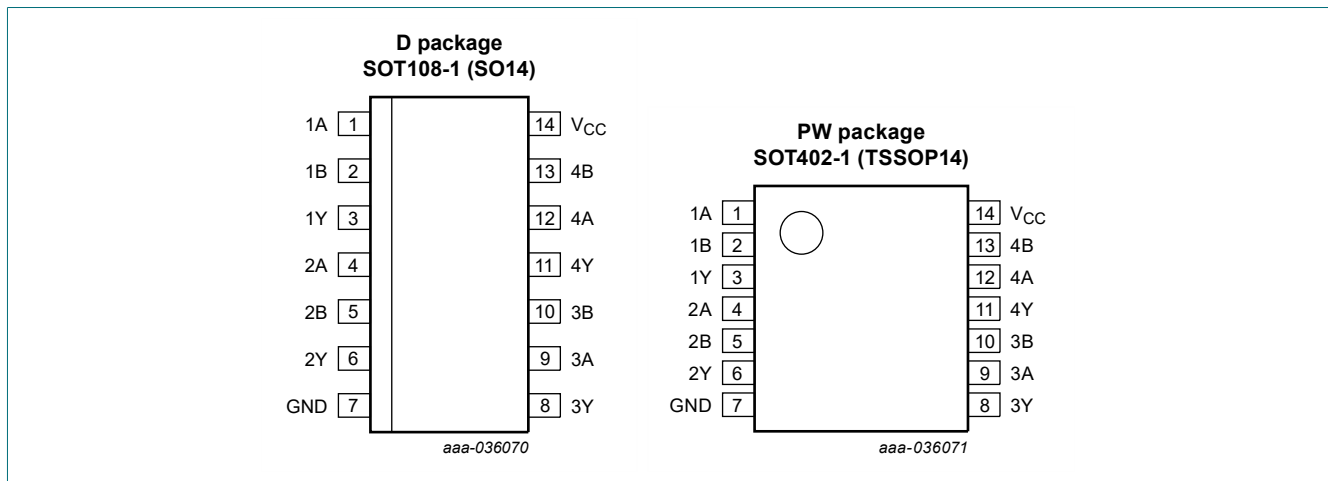
Type number	Package			Version
	Temperature range	Name	Description	
74HC03D-Q100 74HCT03D-Q100	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HC03PW-Q100 74HCT03PW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1

4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

Input		Output
nA	nB	nY
L	L	Z
L	H	Z
H	L	Z
H	H	L

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7	V
V_O	output voltage	[1]	-0.5	+7	V
I_{IK}	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$	[1]	± 20	mA
I_{OK}	output clamping current	$V_O < -0.5\text{ V}$	[1]	-20	mA
I_O	output current	$-0.5\text{ V} < V_O$	-	-25	mA
I_{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.
For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC03-Q100			74HCT03-Q100			Unit
			Min	Typ	Max	Min	Typ	Max	
V_{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V_I	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
V_O	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 2.0\text{ V}$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5\text{ V}$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0\text{ V}$	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC03-Q100										
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
	I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V	
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 6.0 V	-	0.1	-	-	±1	-	±1	μA
I _{OZ}	OFF-state output current	V _I = V _{IL} ; V _{CC} = 6.0 V; V _O = V _{CC} or GND	-	-	±0.5	-	±5.0	-	±10	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	2.0	-	-	20	-	40	μA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT03-Q100										
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 5.5 V	-	-	±0.1	-	±1	-	±1	μA
I _{OZ}	OFF-state output current	V _I = V _{IL} ; V _{CC} = 5.5 V; V _O = V _{CC} or GND	-	-	±0.5	-	±5.0	-	±10	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	2.0	-	20	-	40	μA
ΔI _{CC}	additional supply current	per input pin; V _I = V _{CC} - 2.1 V; I _O = 0 A; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V	-	100	360	-	450	-	490	μA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

$GND = 0\text{ V}$; $C_L = 50\text{ pF}$; for test circuit, see Fig. 5.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C	-40 °C to +125 °C	Unit
			Min	Typ	Max	Max	Max	
74HC03-Q100								
t_{pd}	propagation delay	nA, nB to nY; see Fig. 4 [1]						
		$V_{CC} = 2.0\text{ V}$	-	28	95	120	145	ns
		$V_{CC} = 4.5\text{ V}$	-	10	19	24	29	ns
		$V_{CC} = 5.0\text{ V}$; $C_L = 15\text{ pF}$	-	8	-	-	-	ns
		$V_{CC} = 6.0\text{ V}$	-	8	16	20	25	ns
t_t	transition time	see Fig. 4 [2]						
		$V_{CC} = 2.0\text{ V}$	-	19	75	95	110	ns
		$V_{CC} = 4.5\text{ V}$	-	7	15	19	22	ns
		$V_{CC} = 6.0\text{ V}$	-	6	13	16	19	ns
C_{PD}	power dissipation capacitance	per package; $V_I = GND$ to V_{CC} [3]	-	4	-	-	-	pF
74HCT03-Q100								
t_{pd}	propagation delay	nA, nB to nY; see Fig. 4 [1]						
		$V_{CC} = 4.5\text{ V}$	-	12	24	30	36	ns
		$V_{CC} = 5.0\text{ V}$; $C_L = 15\text{ pF}$	-	10	-	-	-	ns
t_t	transition time	$V_{CC} = 4.5\text{ V}$; see Fig. 4 [2]	-	7	15	19	22	ns
C_{PD}	power dissipation capacitance	per package; $V_I = GND$ to $V_{CC} - 1.5\text{ V}$ [3]	-	4	-	-	-	pF

[1] t_{pd} is the same as t_{PLZ} and t_{PZL} .

[2] t_t is the same as t_{THL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

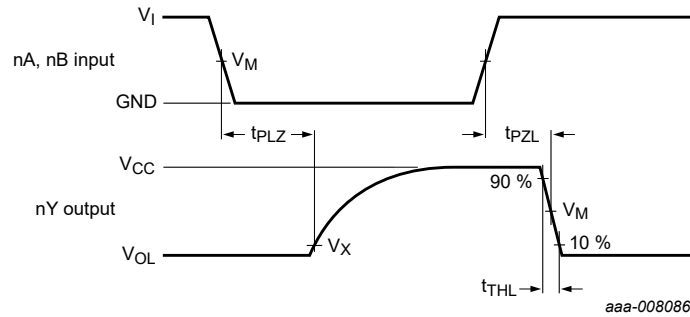
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit



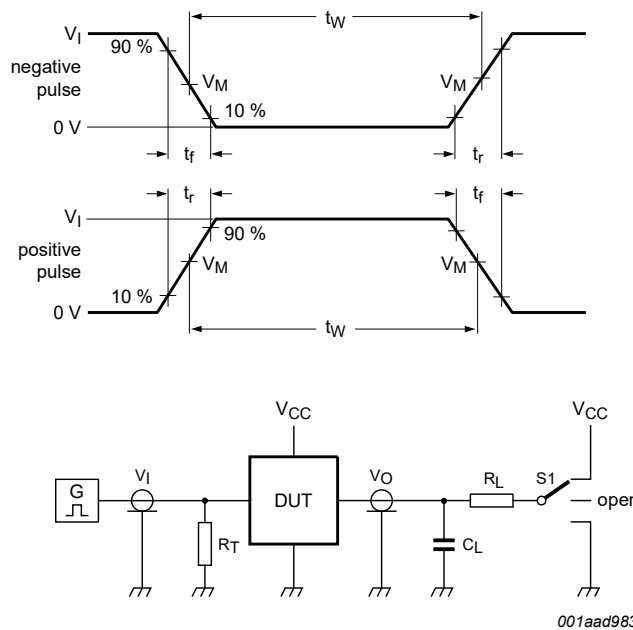
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 4. Input to output propagation delays

Table 8. Measurement points

Type	Input		Output	
	V_M		V_M	V_X
74HC03-Q100	$0.5 \times V_{CC}$		$0.5 \times V_{CC}$	$0.1 \times V_{CC}$
74HCT03-Q100	1.3 V		1.3 V	$0.1 \times V_{CC}$



Test data is given in [Table 9](#).

Definitions test circuit:

R_T = termination resistance should be equal to output impedance Z_o of the pulse generator;

C_L = load capacitance including jig and probe capacitance.

Fig. 5. Test circuit for measuring switching times

Table 9. Test data

Type	Input		Load		S1 position
	V_I	t_r, t_f	C_L	R_L	
74HC03-Q100	V_{CC}	6 ns	15 pF, 50 pF	1 k Ω	V_{CC}
74HCT03-Q100	3.0 V	6 ns	15 pF, 50 pF	1 k Ω	V_{CC}

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

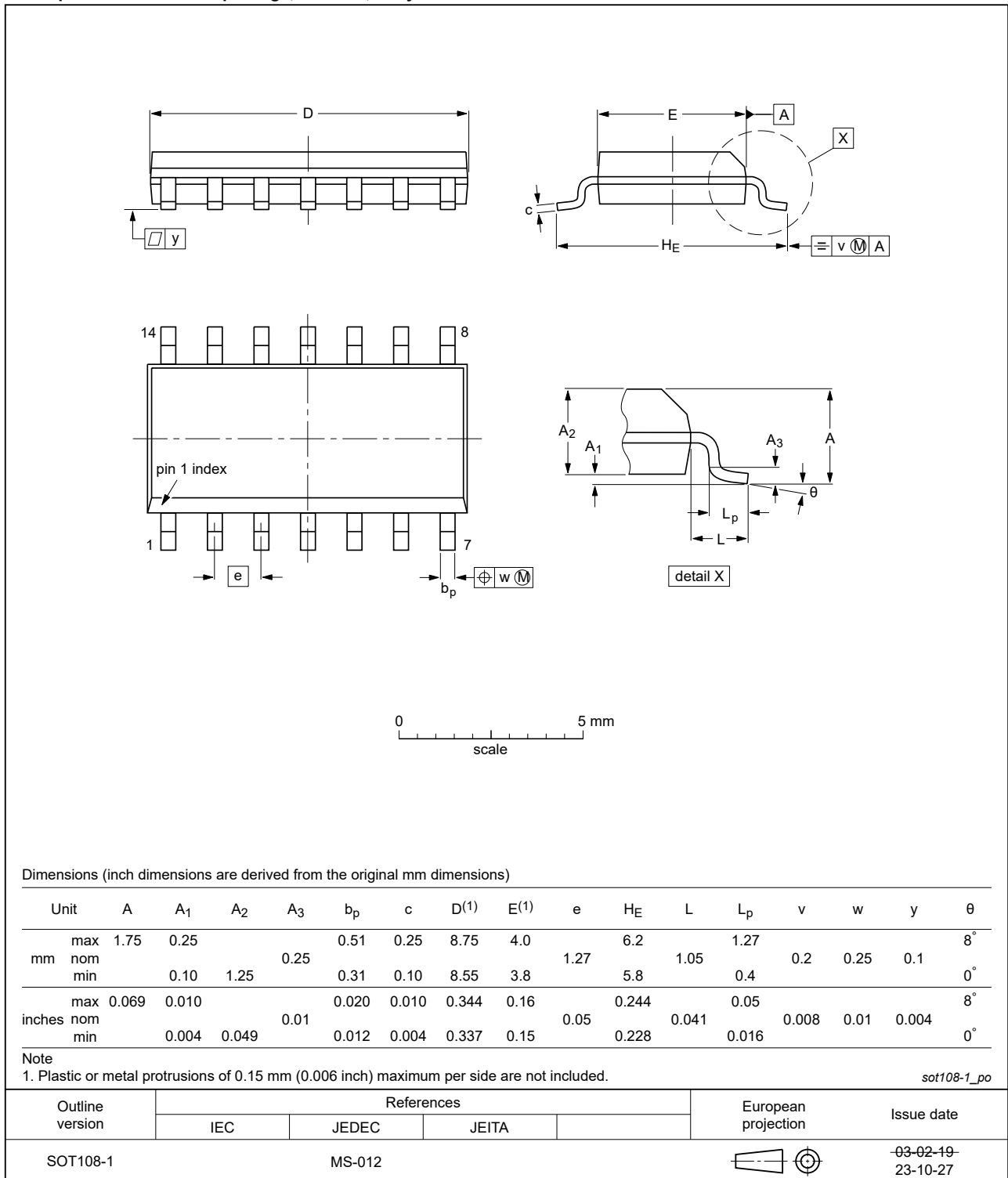


Fig. 6. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

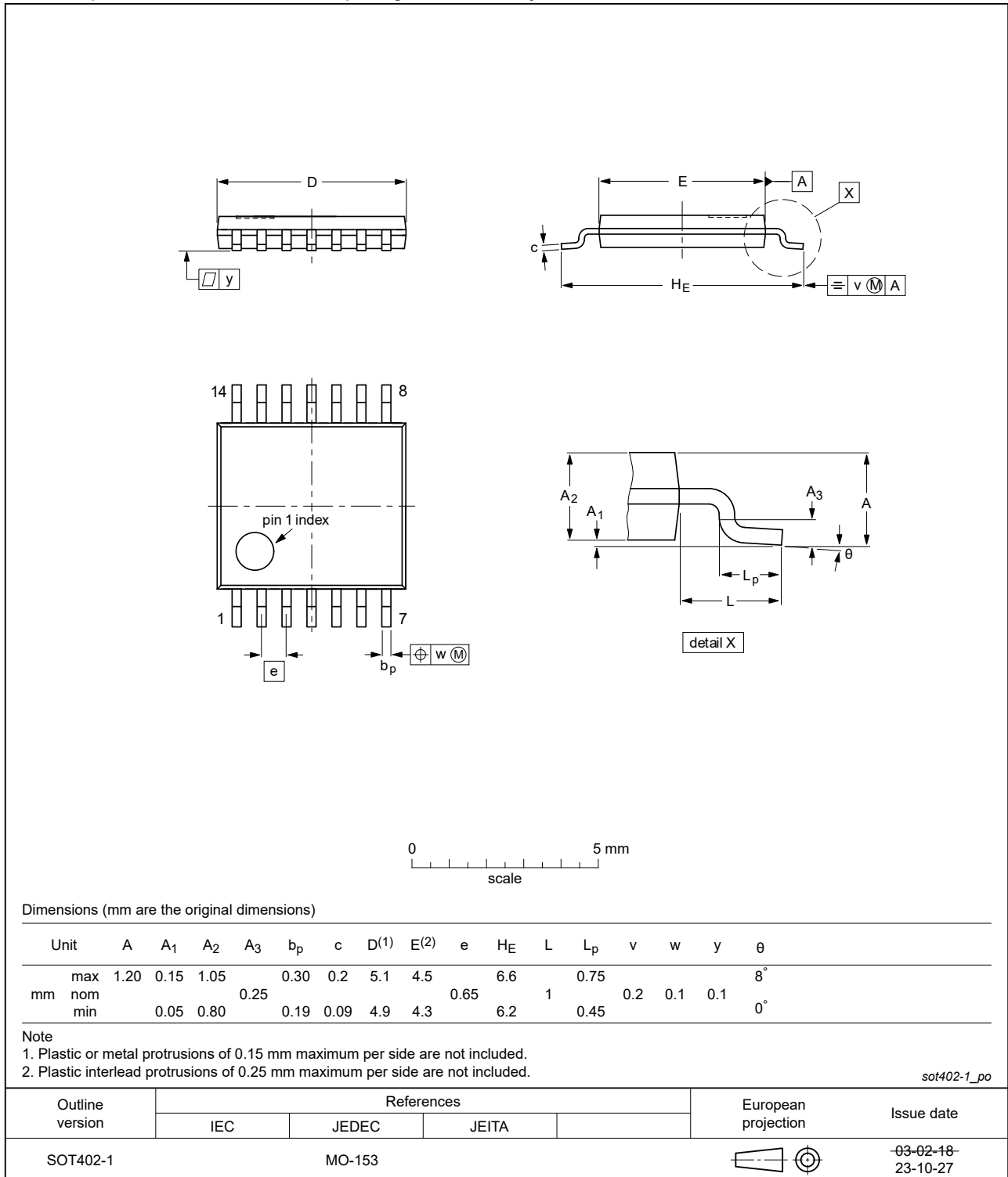


Fig. 7. Package outline SOT402-1 (TSSOP14)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT03_Q100 v.4	20240216	Product data sheet	-	74HC_HCT03_Q100 v.3
Modifications:	<ul style="list-style-type: none"> • Section 2: ESD specification updated according to the latest JEDEC standard. • Fig. 6, Fig. 7: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153 			
74HC_HCT03_Q100 v.3	20210810	Product data sheet	-	74HC_HCT03_Q100 v.2
Modifications:	<ul style="list-style-type: none"> • Section 2 updated. 			
74HC_HCT03_Q100 v.2	20210107	Product data sheet	-	74HC_HCT03_Q100 v.1
Modifications:	<ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Type numbers 74HC03DB-Q100, 74HCT03DB-Q100 (SOT337-1 / SSOP14) removed. • Section 7: Derating values for P_{tot} total power dissipation have been updated. 			
74HC_HCT03_Q100 v.1	20130704	Product data sheet	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 16 February 2024

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